

PRELIMINARY SPECIFICATIONS



Customer Part No.: _____ HELE. Part No: **S2H024576D3CHA-T**
Application For: _____ Products: **OSCILLATOR**
Accepted Model: _____ Type & Freq.: **HSO221S / 24.576MHz**
Sample Order No: _____ Date: **2013/01/07**

Approved By :

加高電子股份有限公司

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HSO221S SPECIFICATION

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1. Type Name :
HSO221S

2. Output Frequency :
24.576000MHz

3. Absolute Maximum Ratings :

Item	Symbol	Value	Unit
Vdd terminal voltage	Vdd	-0.5 ~ 4.0	V
Input terminal voltage	Vcont	-0.5 ~ Vdd+0.5	V
Output terminal voltage	Vout	-0.5 ~ Vdd+0.5	V
Output terminal current	Iout	20	mA
Storage temp. range	Tstr	-55 ~ 125	deg.C

4. Electric Specifications :

Item	Symbol	Value			Unit	Condition		
		Min	Typ	Max		Etc	Vdd	Temp
Frequency Stability	$\Delta f/F$	-20	-	+20	ppm		3.3+/-0.3V	-20~70 °C
Operating temp. range	Topr	-20	25	70	°C			
Supply voltage	Vdd	3.0	3.3	3.6	V			
Current consumption 1 (#1 pin: open or "H")	Idd1	-	-	7	mA	Fig1,2	3.3V	25+/-3 °C
Current consumption 2 (#1 pin: "L" level)	Idd2	-	-	0.01	mA			
Symmetry	Duty	40	50	60	%			
Low level output voltage	Vol	-	-	0.1xVdd	V			
High level output voltage	Voh	0.9xVdd	-	-	V			
Rise & Fall time	Tr & Tf	-	-	10	ns			
Pin #1 options	YES							
Output load	C-MOS CL=15 pF (Idd1, Idd2 test at No Load)							
Low level input current	Iil	-	-	10	uA	Fig3	3.3V	25+/-3 °C
High Level input current	Iih	-	-	10	uA			
Low level input voltage	Vil	-	-	Vddx0.3	V			
High level input voltage	Vih	Vddx0.7	-	-	V			
Output disable time	Tplz	-	-	150	ns			
Output enable time	Tpzl	-	-	5	ms			
Aging	-	-3	-	3	ppm/year			

F :Output Frequency

Δf =Oscillation Frequency - F

Frequency Stability is inclusive of 25°C

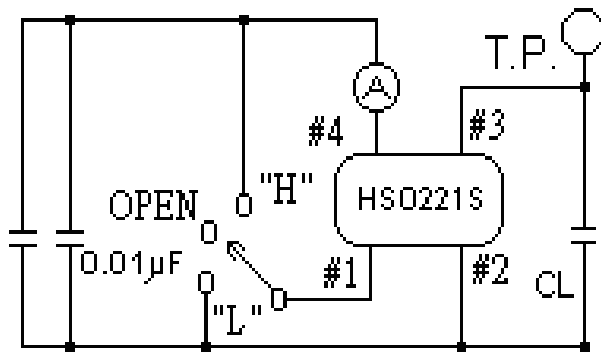
Tolerance, operating temperature range, input voltage change,
Load chang, first of aging , shock and vibration.

Moisture Sensitivity Level : Level 1

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Fig. 1) Measurement Circuit :



CL = Include jig & probe capacitance
(Refer to 4)

Switch	Out term.
H	Oscillation out
Open	Oscillation out
L	High Z

Fig. 2) Output Wave Form :

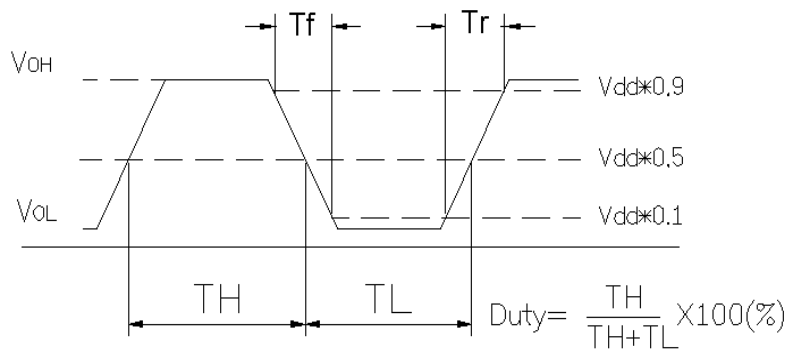
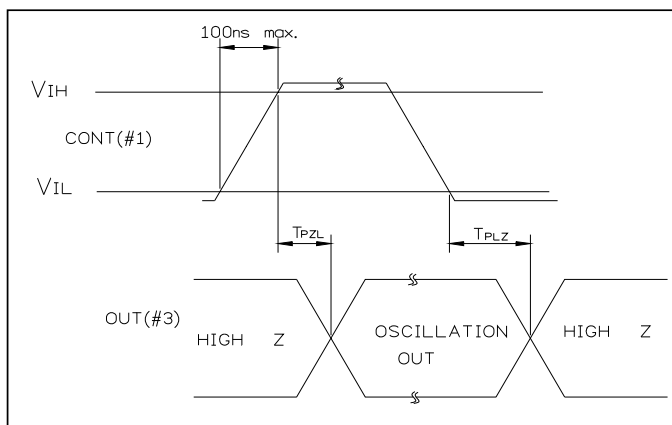
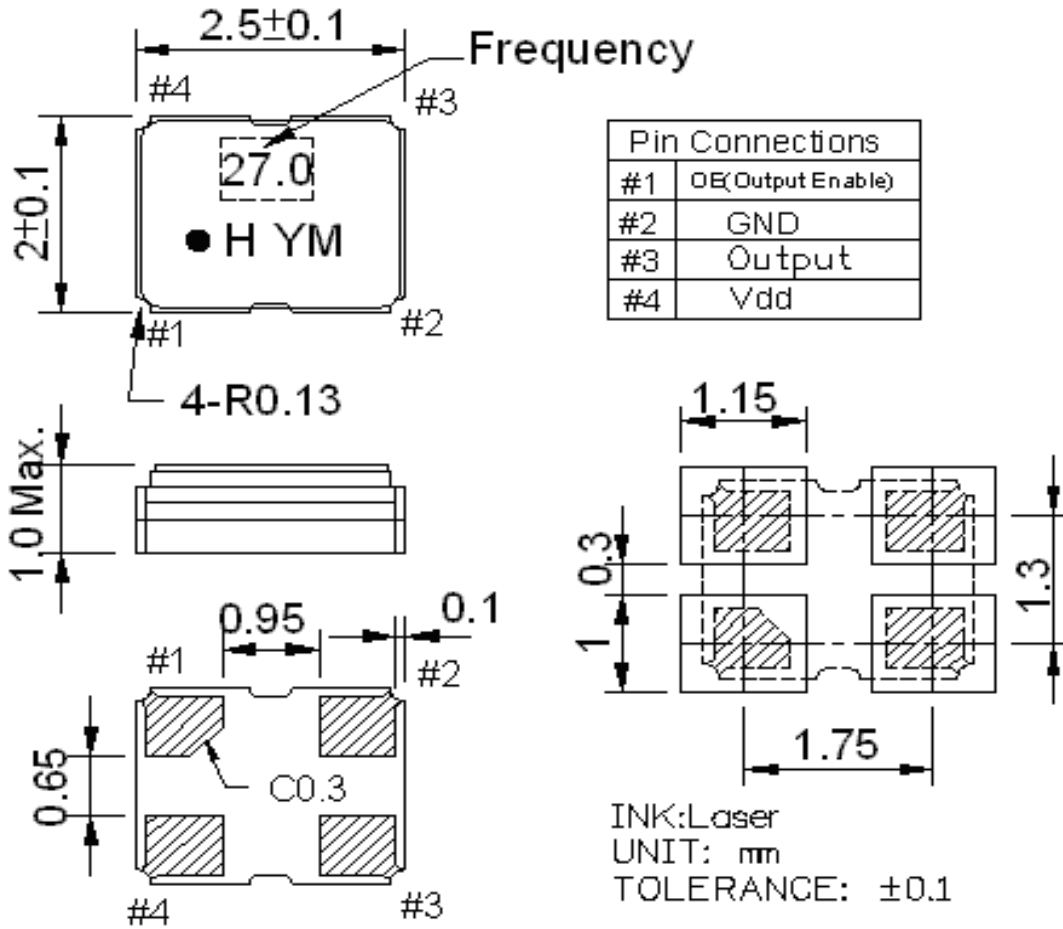


Fig. 3) Input Output Condition :



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5. Dimensions :



Lot No. :

Year : Last digit of the year

Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009
	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019
Code	0	1	2	3	4	5	6	7	8	9

Month : Alphabet assign below

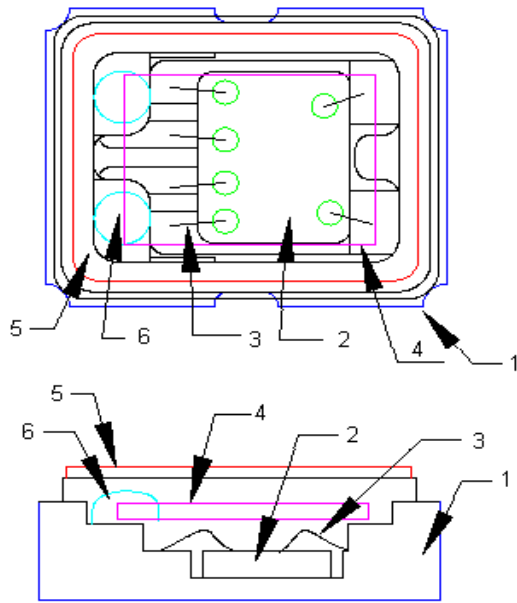
Month	1	2	3	4	5	6	7	8	9	10	11	12
Code	A	B	C	D	E	F	G	H	J	K	L	M

Marking : Laser marking

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6. Inside Structure :



Reference drawing

(1) Base: Alumina Ceramic (Al_2O_3) Metalized Pad: W Ni Plating Au Plating
(2) IC: IC(Si. Al. Ti.)
(3) Au Bonding Wire: Au
(4) Crystal Blank Rectangular At-Cut Quartz Crystal Blank
(5) LID: Fe+Ni+Co
(6) Adhesive Silver Conductive Silicon Resin

The use prohibition chemistry substance of Table 1 of DHE-0204-1 (HE-QA-24) is not included in this item.

7. Mechanical Performance :

Item		Test Methods	Specifications Code
1	Natural Drop	Drop 3 times from the height of 50cm onto min. 30mm thickness hard wooden board.	A
2	Vibration	Frequency 10-55Hz, Sine Wave full amplitude of 0.8mm to X, Y and Z 3 axes, Duration of 2 hours to each axis.	A
3	Sealing Tightness	(1) Leak Rate 1.0×10^{-8} Pa-m ³ /sec. Max. Measured by Helium leak detector. – Fine Leakage. (2) Dipping in the FC-40 at +125 +/-5deg.C for 5 minutes, no gas bubble observed from the inside of the can.	---
4	Solderability	After applying ROSIN Flux, dipping in solder bath at 245deg.C +/-5deg.C for 3 +/-0.5 sec.	B

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8. Environment Performance :

Item		Test Methods	Specifications Code
1	Humidity	Temperature 60°C +/-2°C, RH 90~95%, Duration of 240 hours. Back to room temperature first, then in 1~2 hours, the component shall be checked.	A
2	Storage in Low Temperature	-40deg.C +/-2deg.C, Duration of 240 hours. Back to the room temperature first, then in 1~2 hours, the component shall be checked.	A
3	Storage in High Temperature	+85deg.C +/-2deg.C, Duration of 240 hours. Back to the room temperature first, then in 1~2 hours, the component shall be checked.	A
4	Temperature cycles	-30deg.C +/-2deg.C (30min) ↔ +80deg.C +/-2deg.C (30min) 25 cycles. Temp. increasing or reducing time need to be within 3 minutes. Back to the room temperature first, then in 1~2 hours, the component shall be checked.	A
5	High Temperature Operation	+85deg.C +/-2deg.C, +3.3V Vdd Duration of 240 hours. Back to the room temperature first, then in 1~2 hours, the component shall be checked.	A

Specifications code	Specifications
A	Frequency variation shall be within +/-5ppm and equivalent resistance shall be within the specification after the test
B	More than 90% of lead shall be covered by new solder.

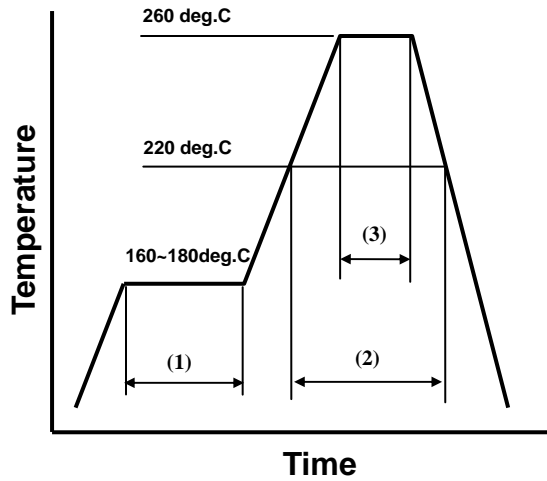
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9. Supplement :

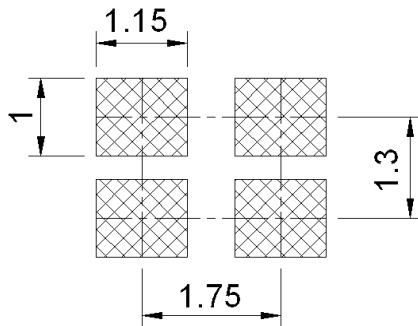
9.1. Please stay with our proposed reflow condition and do then soldering 2 times max.

Available for Lead Free Soldering



(1)	Preheat	160~180 deg.C	120sec.
(2)	Primary heat	220 deg.C	60sec.
(3)	Peak	260 deg.C	10sec. Max.

9.2. Land Pattern Layout : (Example)



9.3. Solder Iron : (Example)

Bit temp.: 350 deg.C Max. , Time: 3sec Max. , Each terminal solder a 1 time Max.

9.4. Mounting :

This component is designed for automatic insertion.

However, you are requested to do the trial with your insertion machine in order to be sure of proper operation and no damage of component.

Please pay attention to board warp which may damage the component and cause Soldering Process.

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9.5.Cleaning :

Cleaning liquid which corrodes Nickel shall not be used.
 It may cause the problem on the surface, color, marking etc.
 Ultra-sonic cleaning is possible, however, you are requested to check on your board.
 Because we only checked as single unit.

9.6.Handling :

HSO221S series is designed to withstand Drop and Vibration, however, the crystal blank might be broken. So, if excess force is given, please check the characteristics before use.
 HSO221S series has C-MOS circuit inside. Please pay attention to static-electricity as same handling as other C-MOS. devices.

9.7.By-pass Capacitor :

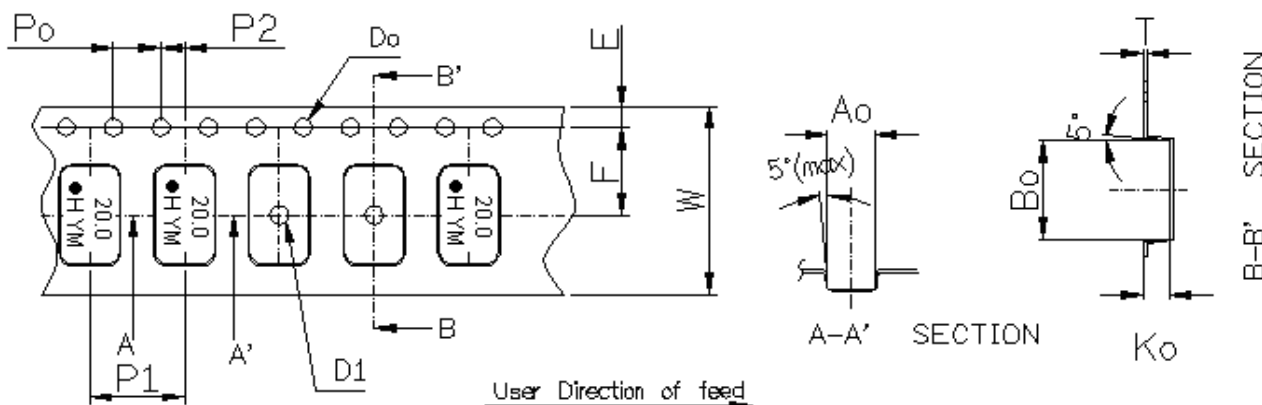
It has no by-pass capacitor integrated. We recommend you to use capacitor (like ceramic chip capacitor) $0.01 \mu F$ in-between Vdd and GND.

9.8.Storage :

Please keep away from high temperature and high humidity, which may cause put solderbility. No direct Sunlight, No dew as well.

10. Taping and Packing :

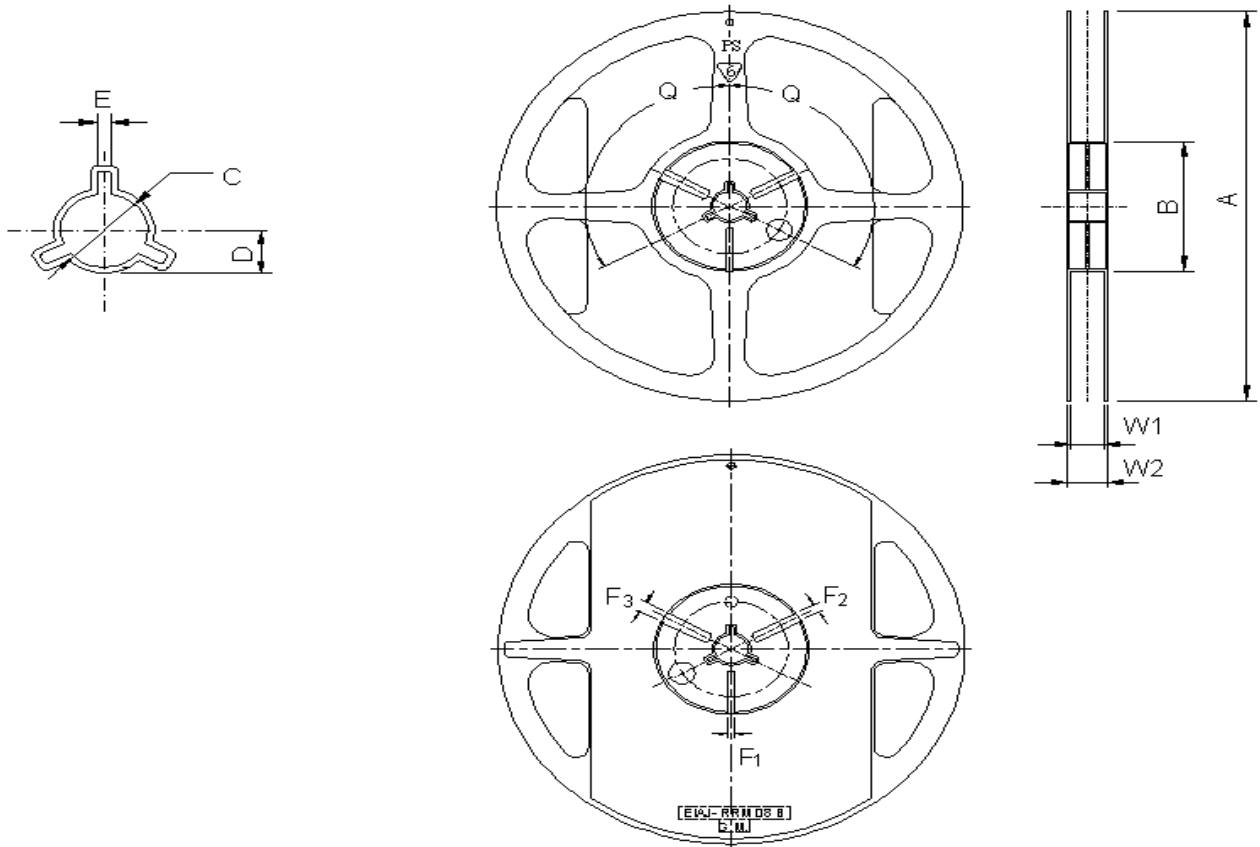
10.1.Emboss Tape Specifications :



Symbol	Ao	Bo	Ko	Po	P1	P2
Spec	2.25±0.05	2.7±0.05	1.15±0.05	4.0±0.1	4.0±0.1	2.0±0.05
Symbol	E	F	Do	D1	W	T
Spec	1.75±0.1	3.5±0.05	∅1.55±0.05	∅1.1±0.1	8.0±0.2	0.25±0.05

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10.2.Reel Specifications :



(Table-2)

(UNIT: mm)

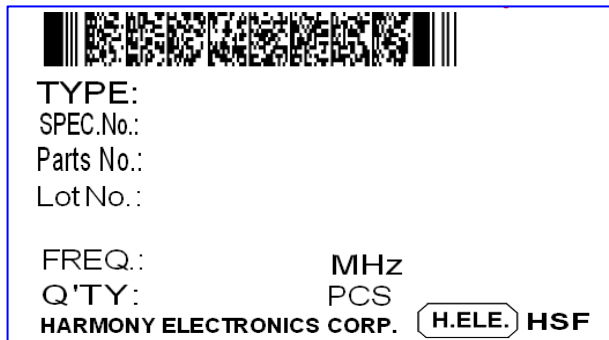
ITEM		MARK	DIMENSIONS · ANGLE	
FLANGE	Diameter	A	$\phi 180+0/-3$	
	Inner Width	W1	$9.3+/-0.3$	
	Outer Width	W2	$11.3+/-1.0$	
HUB	Out Line diameter	B	$\phi 60.5+/-0.5$	
	Center Core slit	Width	F1	$3.0+0.5/-0$
			F2	$4.0+0.5/-0$
			F3	$5.0+0.5/-0$
	Position		q	120deg
	Spindle diameter		C	$\phi 13.2+/-0.5$
Key Ditch	Width	E	$3.0+/-0.2$	

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10.3.Storage :
Temperature+40deg.C Max.
Humidity 80% Max.

10.4.Quantity on Reel :
3,000 PCS/REEL

10.5.Label :
Label is following information :

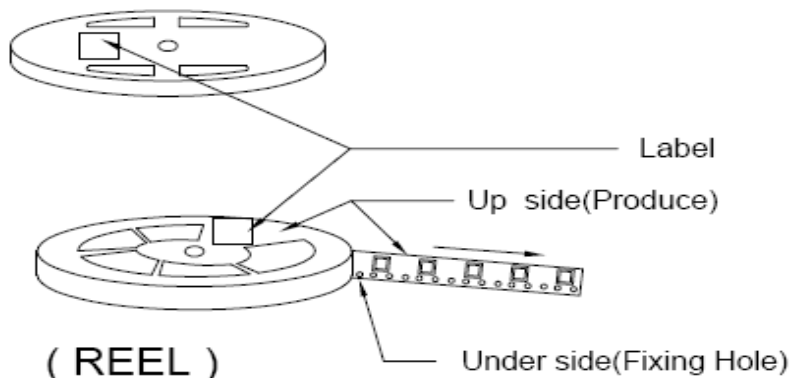


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10.6. PACKAGE :

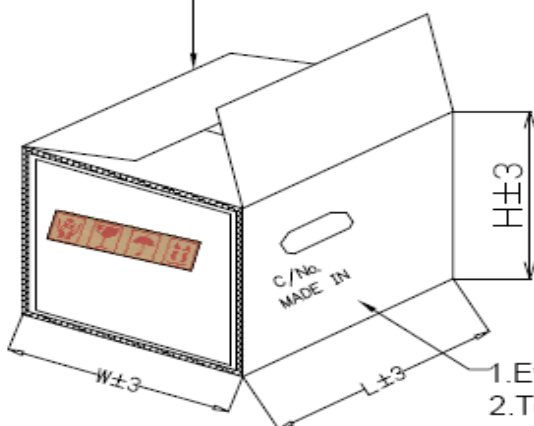
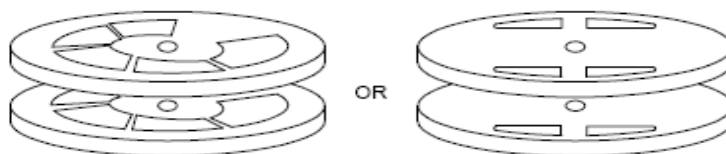
1.Reel : \varnothing 180



(REEL)

2.Cartan One reel quantity:[1000pcs] &[3000pcs]

- ①Top and bottom with 2.3cm thickness foam-rubber cushion for protection.
- ②Carton's Q'TY:1~15 pcs.
- ③Carton Type=A,B,C use 4 trigon pillar to fasten the Reel.
- ④Need to add 3 pages dry agent in each outer box.



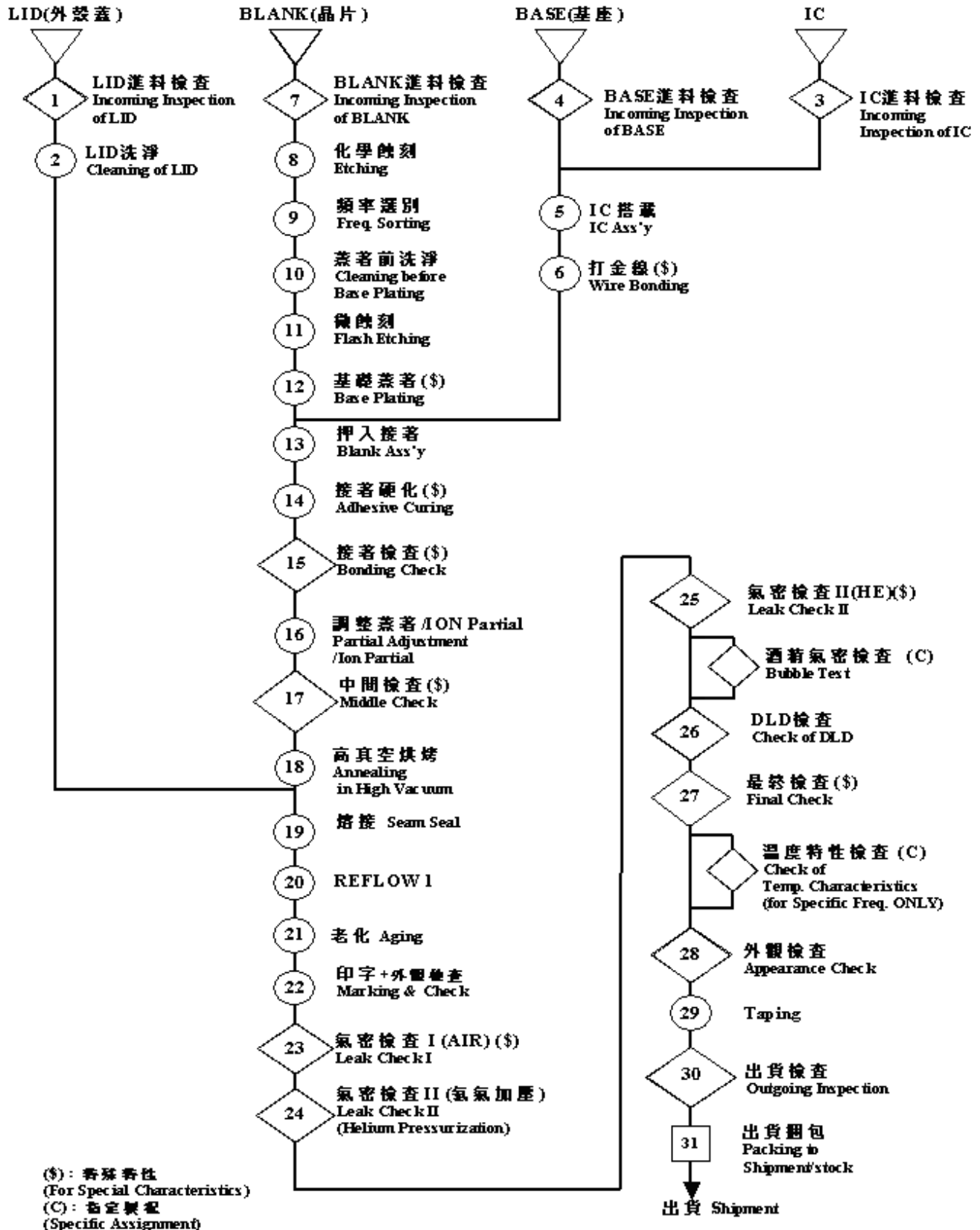
(Carton)

Carton Type	A	B	C	D
Produce Type	840/751	630/531/ 421	321/21	OTHER
Reel	15	15	15	1~7
L±3	200	200	200	195
W±3	200	200	200	195
H±3	230	230	230	150

- 1. Every Carton with 3 desiccant.
- 2. Top and bottom with 2.3cm thickness foam-rubber cushion for protection

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11. Flow Chart :



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